

SV1020i

Ultimate 1U Server Unlocks Business Agility



Intel Whitley Platform Solution

The Intel's first 10nm 3rd generation Intel® Xeon® scalable processors empower the system to support dynamic computational workloads, and accelerate business outcomes through significant breakthrough in core architecture, performance and security.

OCP 3.0 Add-On Card Support

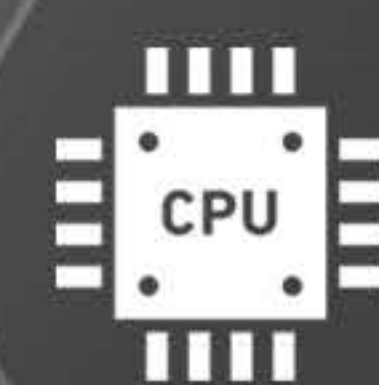
The standard-compliant OCP 3.0 slot enables the installation of a high-speed NIC card, which delivers high bandwidth and ultra-low latency in a cluster environment.

Flexible I/O Configurations

Up to 4 PCIe Gen4 x16 slots are accessible through the rear of the system for users to install 2 FHHL PCIe cards or 3 HHHL cards in a slim 1U form factor, providing great flexibility as well as versatile I/O capability.

Application

- Head Node Server
- High Performance Computing
- Hyperscale Data Center
- Software-defined Storage
- Enterprise Application Server
- Virtualization



One/Two 3rd Gen.
Intel® Xeon®
Scalable Processor(s)



32 x DDR4 RDIMM/
LRDIMM



12 x 2.5"
NVMe/SATA Drives



1+1 Redundancy,
Platinum Level



1U Rackmount

SV1020i

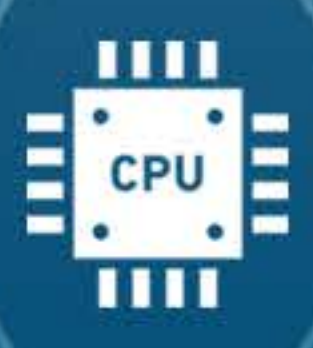
Specifications



North America: +1 408-727-8060



Email: Sales@ingrasys.com



Processor

One/Two 3rd Gen. Intel® Xeon® Scalable Processor(s)



Memory

Up to 32 x DDR4 3200MHz RDIMM/LRDIMM
Support Intel Optane Persistent Memory
200 Series Module



Storage

Front

12 x 2.5" Hot-swap NVMe/SATA Drives
Support Intel VROC

Internal

2 x Gen3 NVMe M.2 (22110)
1 x USB3.0 (Type A)
1 x USB2.0 Header
1 x 7-P SATA Port



RAID Controller

1 x Intel® VROC RAID Upgrade Key
(VROC 7.5, RAID 0/1/5/10)



Front Panel

1 x Power Button with LED
1 x UID Button with LED / 1 x Reset Button
1 x System Health LED



Rear Panel

3 HHHL Card SKU or 2 FHHL Card SKU
1 x RJ45 for BMC Dedicated Management
1 x VGA / 2 x USB 3.0
1 x Power Status LED / 1 x UID LED
1 x System Health LED



Security

1 x TPM 2.0 Module
Lattice MachXO3D Root-of-Trust
Engine



Expansion Slots

Up to 4 x PCIe Gen4 x16 Slots
1 x OCP 3.0 NIC PCIe Gen4 x16 Slot
2 x Internal LP-SlimSAS Connectors
(Gen4 x8)



Management

1 x ASPEED AST2500 BMC per Node
Support Intelligent Platform Management
Interface v.2.0



PSUs

1+1 Redundant 1600W
Platinum Power Supplies



Fans

8 x 40*56mm Dual Rotor
System Fans



Certification

UL/CB/CE/FCC/IC/
BSMI



Chassis Dimensions (H x W x D)

1.71" x 17.32" x 29.88" /
43.5mm x 440.0mm x 777.8mm



Form Factor

1U Rackmount



Operating Temperature

0°C to 35°C (32°F to 95°F)

Non-operating Temperature

-40°C to 70°C (-40°F to 158°F)

Operating Relative Humidity

8% to 85%RH

Non-operating Relative Humidity

5% to 95%RH



The information in this document is subject to change without notice. Ingrasys, the Ingrasys logo are trademarks or registered trademarks of Ingrasys Technology Inc. All logos, trademarks and registered trademarks are the property of their respective owners.

© 2021 Ingrasys Technology Inc. All rights reserved.